

MB89P637P-G-SH-TLE1 Information


For Reference Only

Part Number [MB89P637P-G-SH-TLE1](#)
Manufacturer Cypress Semiconductor Corp
Category Integrated Circuits (ICs)
[Embedded - Microcontrollers](#)
Description IC MCU 8BIT 32KB OTP 64SHDIP
Package 64-DIP (0.750", 19.05mm)
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


MB89P637P-G-SH-TLE1 Specifications

Manufacturer Part Number	MB89P637P-G-SH-TLE1
Manufacturer	Cypress Semiconductor Corp
Category	Integrated Circuits (ICs) Embedded - Microcontrollers
Package	64-DIP (0.750", 19.05mm)
Series	F2MC-8L MB89630
Core Processor	F2MC-8L
Core Size	8-Bit
Speed	10MHz
Connectivity	EBI/EMI, Serial I/O, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	53
Program Memory Size	32KB (32K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7 V ~ 6 V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	64-DIP (0.750", 19.05mm)
Supplier Device Package	64-SH-DIP

[Report errors?](#)

MB89P637P-G-SH-TLE1 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MB89P637P-G-SH-TLE1 Payment Methods



MB89P637P-G-SH-TLE1 Shipping Methods



If you have any question about MB89P637P-G-SH-TLE1, please do not hesitate to contact us!

Website: <https://www.heisener.com>

E-mail: salesdept@heisener.com